

## PSMN6R7-40MLD

N-channel 40 V, 6.7 mΩ, logic level MOSFET in LFPAK33 using NextPower-S3 technology 14 August 2019

Product data sheet

### 1. General description

50 A, logic level N-channel enhancement mode MOSFET in 175 °C LFPAK33 package using advanced TrenchMOS Superjunction technology. This product has been designed and qualified for high efficiency applications operating at high switching frequencies.

### 2. Features and benefits

- Avalanche rated, 100% tested
- NextPower-S3 technology delivers 'superfast switching with soft body-diode recovery'
- Low Q<sub>RR</sub>, Q<sub>G</sub> and Q<sub>GD</sub> for high efficiency, especially at higher switching frequencies
- Low spiking and ringing for low EMI designs
- High reliability clip bond and solder die attach Mini Power SO8 package; no glue, no wire bonds, qualified to 175 °C
- Exposed leads can be wave soldered; visual solder joint inspection and high quality solder joints
- Low parasitic inductance and resistance

### 3. Applications

- Secondary side synchronous rectification
- DC-to-DC converters •
- Brushless DC motor drive
- LED lighting

### 4. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
V <sub>DS</sub>	drain-source voltage	25 °C ≤ T <sub>j</sub> ≤ 175 °C		-	-	40	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 25 °C; <u>Fig. 2</u>	[1]	-	-	50	А
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; <u>Fig. 1</u>		-	-	65	W
Tj	junction temperature			-55	-	175	°C
Static chara	acteristics						
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = 4.5 V; I <sub>D</sub> = 15 A; T <sub>j</sub> = 25 °C; Fig. 10		-	7	8.6	mΩ
		V <sub>GS</sub> = 10 V; I <sub>D</sub> = 20 A; T <sub>j</sub> = 25 °C; Fig. 10		-	5.5	6.7	mΩ
Dynamic ch	aracteristics		•				·
Q <sub>G(tot)</sub>	total gate charge	$I_D$ = 20 A; $V_{DS}$ = 20 V; $V_{GS}$ = 4.5 V;		6.5	10	14	nC
Q <sub>GD</sub>	gate-drain charge	<u>Fig. 12; Fig. 13</u>		0.7	2.5	5	nC

[1] 50A continuous current has been successfully demonstrated during application tests. Practically the current will be limited by PCB, thermal design and operating temperature.

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### 5. Pinning information

Table 2. Pinning information									
Pin	Symbol	Description	Simplified outline	Graphic symbol					
1	S	source		D					
2	S	source							
3	S	source		G-(F					
4	G	gate		mbb076 S					
mb	D	Mounting base; connected to drain	LFPAK33 (SOT1210)						

### 6. Ordering information

Table 3. Ordering information								
Type number	Package	Package						
	Name	Description	Version					
PSMN6R7-40MLD	LFPAK33	Plastic, single ended surface mounted package (LFPAK33); 8 leads; 0.65 mm pitch	SOT1210					

### 7. Marking

#### Table 4. Marking codes

Type number	Marking code
PSMN6R7-40MLD	6H7L40

### 8. Limiting values

#### Table 5. Limiting values

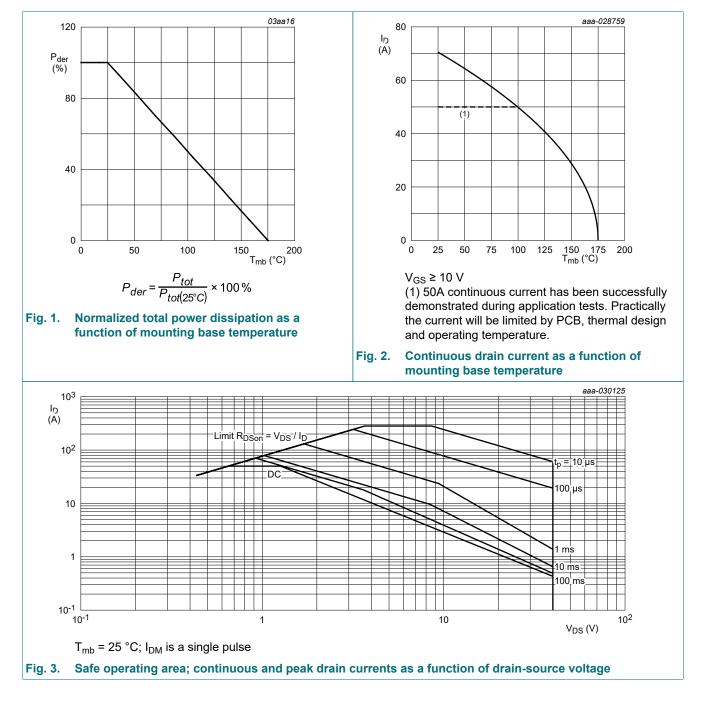
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Мах	Unit
V <sub>DS</sub>	drain-source voltage	$25 \text{ °C} \leq T_j \leq 175 \text{ °C}$		-	40	V
V <sub>DSM</sub>	peak drain-source voltage	$t_p \le 20 \text{ ns}; f \le 500 \text{ kHz}; E_{DS(AL)} \le 200 \text{ nJ};$ pulsed		-	45	V
V <sub>DGR</sub>	drain-gate voltage	25 °C ≤ $T_j$ ≤ 175 °C; $R_{GS}$ = 20 kΩ		-	40	V
V <sub>GS</sub>	gate-source voltage			-20	20	V
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; <u>Fig. 1</u>		-	65	W
I <sub>D</sub>	drain current	V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 25 °C; <u>Fig. 2</u>	[1]	-	50	A
		V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 100 °C; <u>Fig. 2</u>		-	50	A
I <sub>DM</sub>	peak drain current	pulsed; $t_p \le 10 \ \mu s$ ; $T_{mb} = 25 \ ^{\circ}C$ ; Fig. 3		-	282	A
T <sub>stg</sub>	storage temperature			-55	175	°C
Tj	junction temperature			-55	175	°C
T <sub>sld(M)</sub>	peak soldering temperature			-	260	°C
Source-drai	n diode					
I <sub>S</sub>	source current	T <sub>mb</sub> = 25 °C		-	50	А

Symbol	Parameter	Conditions		Min	Max	Unit		
I <sub>SM</sub>	peak source current	pulsed; $t_p \le 10 \ \mu s$ ; $T_{mb} = 25 \ ^{\circ}C$		-	282	А		
Avalanche ruggedness								
E <sub>DS(AL)S</sub>	non-repetitive drain- source avalanche energy	$ \begin{split} &I_{D} = 25 \text{ A};  V_{sup} \leq \ 40 \text{ V};  R_{GS} = 50 \ \Omega; \\ &V_{GS} = 10 \text{ V};  T_{j(init)} = 25 \ ^{\circ}\text{C};  unclamped; \\ &t_{p} = 89.4 \ \mu s \end{split} $	[2]	-	58	mJ		

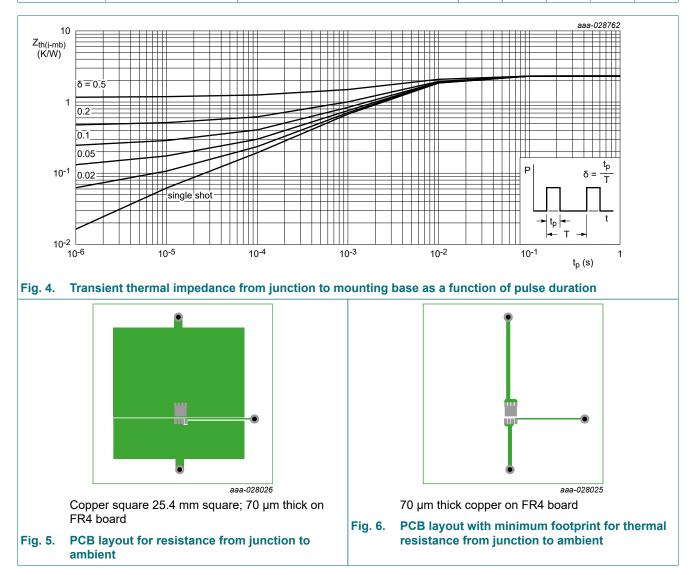
[1] 50A continuous current has been successfully demonstrated during application tests. Practically the current will be limited by PCB, thermal design and operating temperature.

#### [2] Protected by 100% test



#### 9. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
R <sub>th(j-mb)</sub>	thermal resistance from junction to mounting base	Fig. 4	-	2.09	2.32	K/W
R <sub>th(j-a)</sub>	thermal resistance from	Fig. 5	-	50	-	K/W
junction to a	junction to ambient	Fig. 6	-	130	-	K/W



### **10. Characteristics**

Table 7. Characteristics								
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit	
Static characteristics								
V <sub>(BR)DSS</sub>	broakdown voltago	$I_D$ = 250 µA; $V_{GS}$ = 0 V; $T_j$ = 25 °C		40	-	-	V	
		$I_D$ = 250 µA; $V_{GS}$ = 0 V; $T_j$ = -55 °C		36	-	-	V	

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Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
V <sub>GS(th)</sub>	gate-source threshold voltage	$I_{D} = 1 \text{ mA}; V_{DS} = V_{GS}; T_{j} = 25 \text{ °C}$	1.45	1.77	2.15	V
ΔV <sub>GS(th)</sub> /ΔT	gate-source threshold voltage variation with temperature	25 °C ≤ T <sub>j</sub> ≤ 150 °C	-	-4.3	-	mV/K
I <sub>DSS</sub>	drain leakage current	V <sub>DS</sub> = 32 V; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	0.002	1	μA
		V <sub>DS</sub> = 32 V; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 125 °C	-	0.77	-	μA
I <sub>GSS</sub>	gate leakage current	V <sub>GS</sub> = 16 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	2	100	nA
		$V_{GS}$ = -16 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C	-	2	100	nA
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 20 A; T <sub>j</sub> = 25 °C; Fig. 10	-	5.5	6.7	mΩ
		V <sub>GS</sub> = 10 V; I <sub>D</sub> = 20 A; T <sub>j</sub> = 175 °C; <u>Fig. 11</u>	-	-	13	mΩ
		V <sub>GS</sub> = 4.5 V; I <sub>D</sub> = 15 A; T <sub>j</sub> = 25 °C; <u>Fig. 10</u>	-	7	8.6	mΩ
		V <sub>GS</sub> = 4.5 V; I <sub>D</sub> = 15 A; T <sub>j</sub> = 175 °C; <u>Fig. 11</u>	-	-	16.7	mΩ
R <sub>G</sub>	gate resistance	f = 1 MHz; T <sub>j</sub> = 25 °C	0.3	0.8	1.9	Ω
Dynamic cha	racteristics		·			·
Q <sub>G(tot)</sub>	total gate charge	$I_D = 20 \text{ A}; V_{DS} = 20 \text{ V}; V_{GS} = 10 \text{ V};$ Fig. 12; Fig. 13	14	22	31	nC
		$I_D = 20 \text{ A}; V_{DS} = 20 \text{ V}; V_{GS} = 4.5 \text{ V};$	6.5	10	14	nC
Q <sub>GS</sub>	gate-source charge	Fig. 12; Fig. 13	2.4	4.1	6.2	nC
Q <sub>GS(th)</sub>	pre-threshold gate- source charge		1.38	2.3	3.45	nC
Q <sub>GS(th-pl)</sub>	post-threshold gate- source charge		1.1	1.8	2.7	nC
Q <sub>GD</sub>	gate-drain charge		0.7	2.5	5	nC
V <sub>GS(pl)</sub>	gate-source plateau voltage	I <sub>D</sub> = 20 A; V <sub>DS</sub> = 20 V; <u>Fig. 12; Fig. 13</u>	-	2.9	-	V
C <sub>iss</sub>	input capacitance	V <sub>DS</sub> = 20 V; V <sub>GS</sub> = 0 V; f = 1 MHz;	961	1479	2071	pF
C <sub>oss</sub>	output capacitance	T <sub>j</sub> = 25 °C; <u>Fig. 14</u>	280	432	605	pF
C <sub>rss</sub>	reverse transfer capacitance		18	60	132	pF
t <sub>d(on)</sub>	turn-on delay time	$V_{DS} = 20 V; R_L = 1 \Omega; V_{GS} = 4.5 V;$	-	15	-	ns
t <sub>r</sub>	rise time	$R_{G(ext)} = 5 \Omega$	-	21	-	ns
t <sub>d(off)</sub>	turn-off delay time	] [	-	14	-	ns
t <sub>f</sub>	fall time		-	10	-	ns
Q <sub>oss</sub>	output charge	$V_{GS} = 0 V; V_{DS} = 20 V; f = 1 Hz;$ T <sub>j</sub> = 25 °C	-	13	-	nC
Source-drain	diode					
V <sub>SD</sub>	source-drain voltage	I <sub>S</sub> = 20 A; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C; <u>Fig. 15</u>	-	0.85	1.2	V

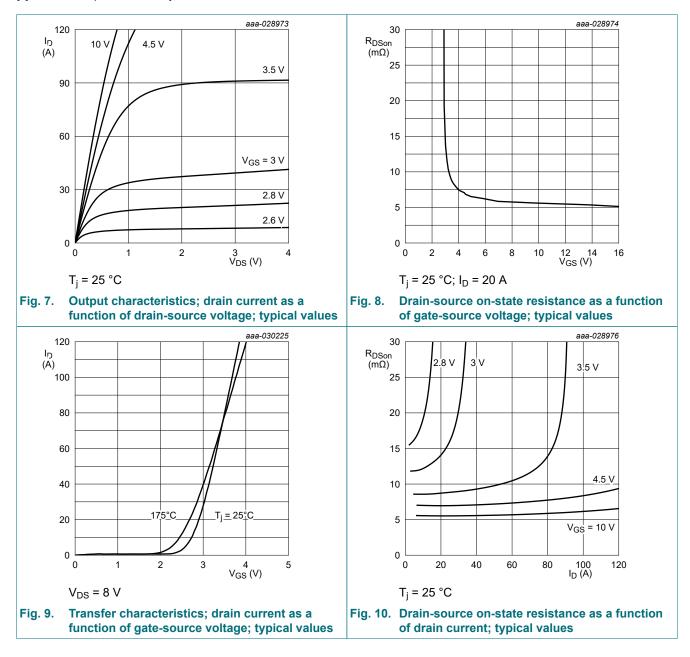
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### PSMN6R7-40MLD

#### N-channel 40 V, 6.7 m $\Omega$ , logic level MOSFET in LFPAK33 using NextPower-S3 technology

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
t <sub>rr</sub>	reverse recovery time	$I_{S} = 20 \text{ A}; \text{ dI}_{S}/\text{dt} = -100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V};$ $V_{DS} = 20 \text{ V}; \text{ T}_{j} = 25 \text{ °C}; \text{ Fig. 16}$ [1]		-	23	-	ns
Qr	recovered charge		[1]	-	16	-	nC
t <sub>a</sub>	reverse recovery rise time			-	14	-	ns
t <sub>b</sub>	reverse recovery fall time			-	8.5	-	ns

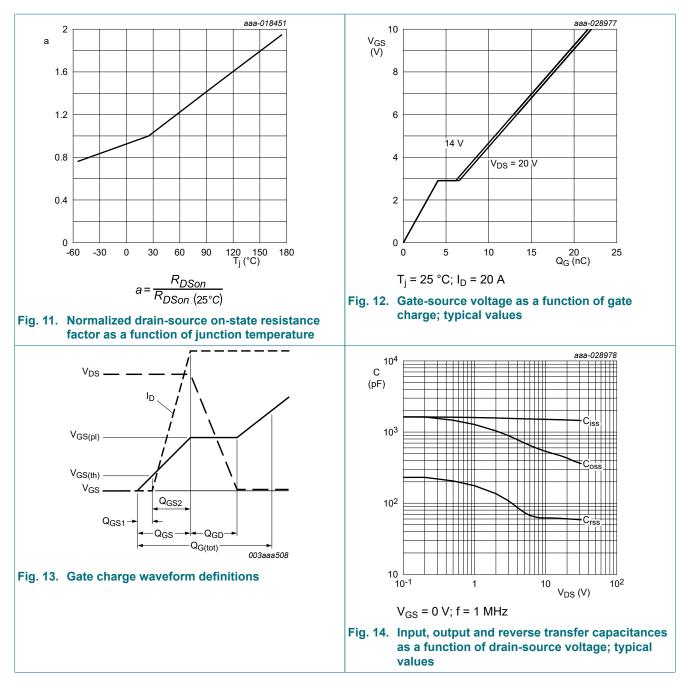
[1] includes capacitive recovery



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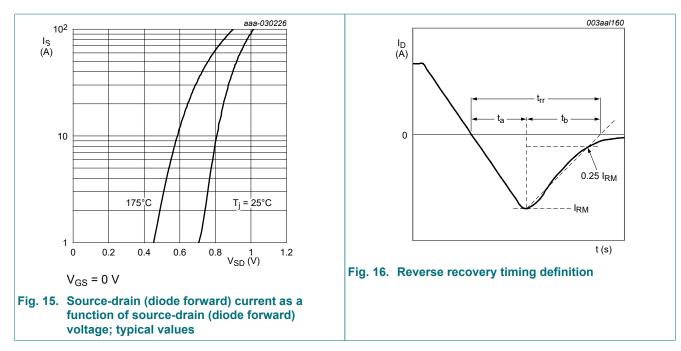
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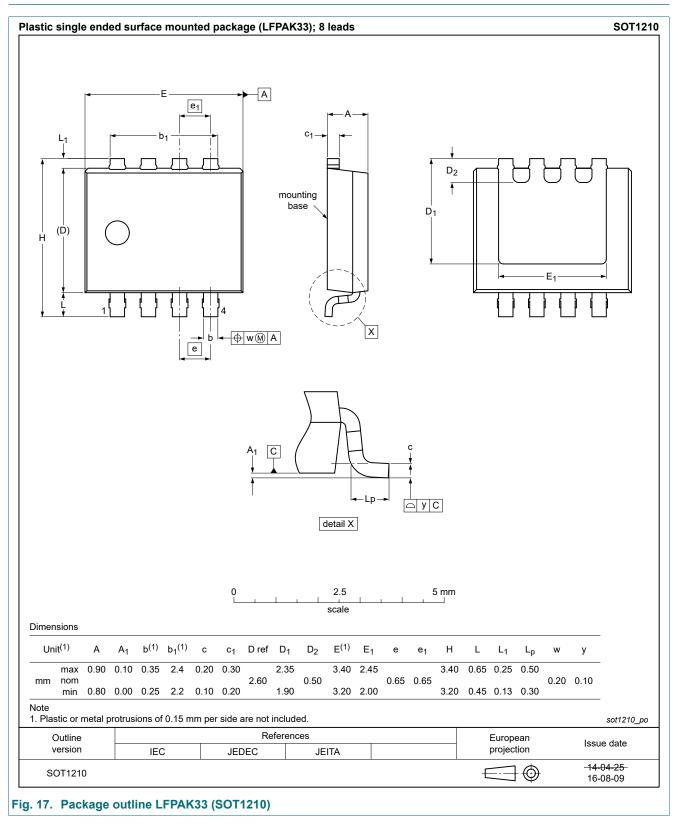
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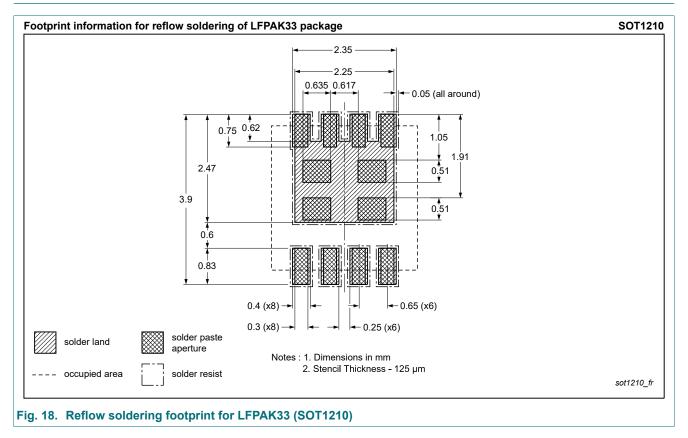


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### 11. Package outline



### 12. Soldering



### 13. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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